EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1	((XUE-JAN) near2 (FAN)).INV.	US-PGPUB; USPAT; USOCR	AND	OFF	2007/12/03 10:56
S2	26	((PENG) near2 (XU)).INV.	US-PGPUB; USPAT; USOCR	AND	OFF	2007/12/03 10:57
S3	0	("2006/0180821").URPN.	USPAT	AND	OFF	2007/12/03 11:26
S4	19	"6226183"	USPAT	AND	OFF	2007/12/03 11:27
S5	31	"6477054" or "5792677" or "20030057534"	USPAT	AND	OFF	2007/12/03 11:43
S6	1	(S4 or S5) (flexible near (substrate or pcb or board))	USPAT	AND	ON	2007/12/03 11:43
S7	15	("5045921" | "5161090" | "5467251" | "5708566" | "5745984" | "5792677").PN. OR ("5896271").URPN.	US-PGPUB; USPAT; USOCR	AND	OFF	2007/12/03 11:45
S10	4752	361/704,719,720.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/12/03 11:50
S11	6615	257/707,98,713,e23.105.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/12/03 11:50
S12	5996	165/80.3,185.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/12/03 11:51
S13	2493	174/252,262.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/12/03 11:51

S14	603	(S10 or S11 or S12 or S13) trace via sink (pcb or board or substrate near (flexible))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2007/12/03 11:52
S15	40	S14 (light adj2 diode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2007/12/03 11:53
S16	12	"60467857"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/12/03 17:15
S17	36	("20020004251" | "20020034834" | "20020163006" | "20020175621" | "20020176250" | "20030057421" | "20040026706" | "4886709" | "5117281" | "5122781" | "5140220" | "5482898" | "5485037" | "5581876" | "5725808" | "5745624" | "5847935" | "5857767" | "5953203" | "5977567" | "6045240" | "6220722" | "6325524" | "6376268" | "6428189" | "6455930" | "6480389" | "6483623" | "6518502" | "6634750" | "6634770" | "6692252").PN. OR ("7095053").URPN.	US-PGPUB; USPAT; USOCR	AND	OFF	2008/07/29 18:15
S18	5118	361/704,719,720.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 08:55
S19	7132	257/707,98,713,e23.105. ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 08:55

S20	6315	165/80.3,185.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 08:55
S21	2656	174/252,262.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 08:55
S22	644	(S18 or S19 or S20 or S21) trace via sink (pcb or board or substrate near (flexible))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:55
S23	830064	S22 (LED) or diode	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:55
S24	140	S22 (LED or diode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:55
S25	119	S24 trace$2 and layer$2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:56
S26	73	S25 (bonding or adhesive near (via or hole))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:57
S27	5	S26 (flexible near (substrate or board))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:58

S28	63	"6428189"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 09:09
S29	2640	(LED or diode) trace via sink (pcb or board or substrate near (flexible))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 09:47
S30	248	S29 (via near (thermal$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 09:48
S31	58	S30 not (S22 or S23 or S24 or S25 or S26 or S27)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 09:49
S32	2	"20050225222"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 10:03
S34	36	"5386339"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 10:14
S35	72	"5604673"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 10:15
S36	21	("5138436").PN. OR ("5604673").URPN.	US-PGPUB; USPAT; USOCR	AND	OFF	2008/07/30 10:26

7/30/2008 3:51:46 PM
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